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(54) **ORGANIC ELECTROLUMINESCENT
DISPLAY DEVICE AND METHOD OF
MANUFACTURING THE SAME**

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ABSTRACT

An organic electroluminescent display device including a rear substrate, an organic electroluminescent portion disposed over a surface of the rear substrate, the organic electroluminescent portion including a first electrode, an organic layer, and a second electrode in sequence, a front substrate opposing the rear substrate and coupled to the rear substrate to seal an internal space therebetween in which the organic electroluminescent portion is accommodated, thereby isolating the organic electroluminescent portion from the outside, a moisture-absorbing layer disposed over an internal surface of the front substrate, and a sealant disposed between the rear substrate and the moisture-absorbing layer to couple the front substrate and the rear substrate.

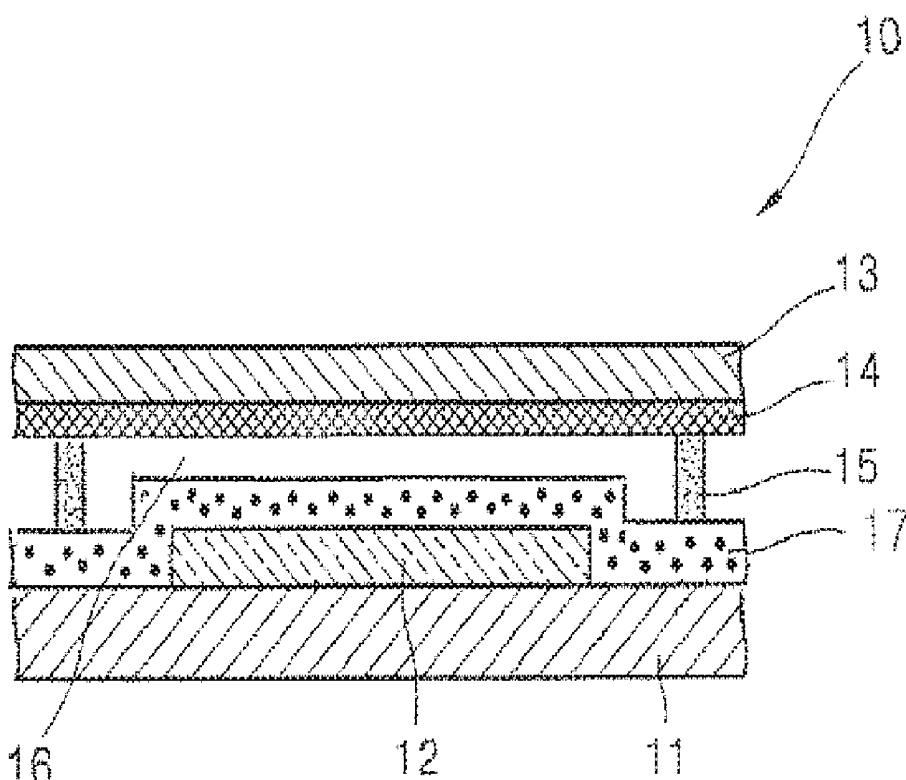


FIG. 1

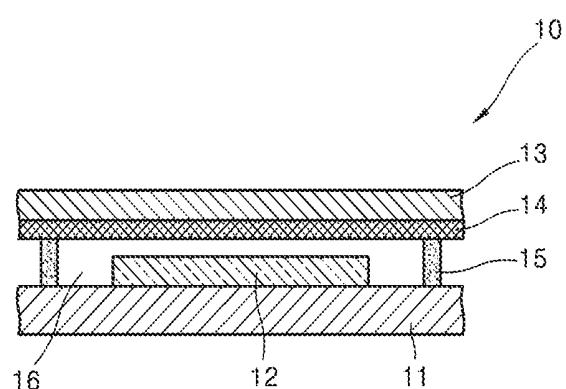


FIG. 2

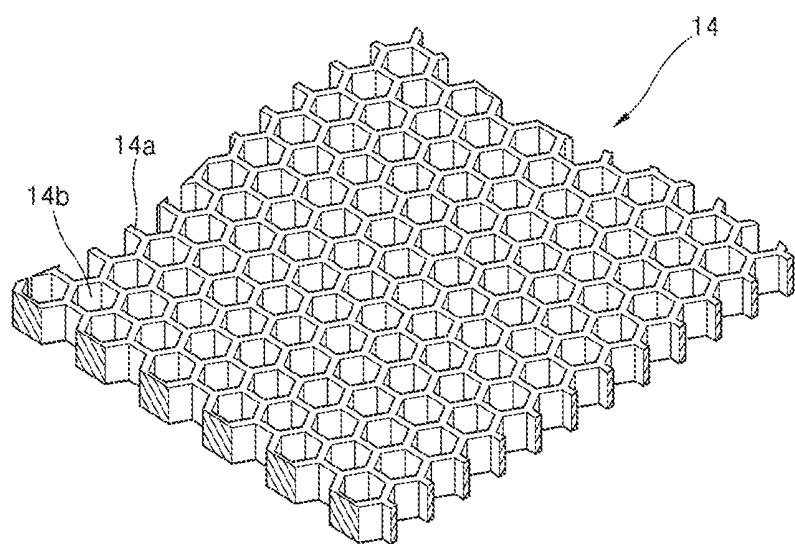


FIG. 3A

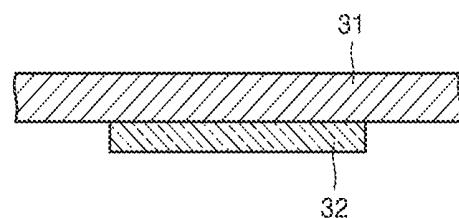


FIG. 3B

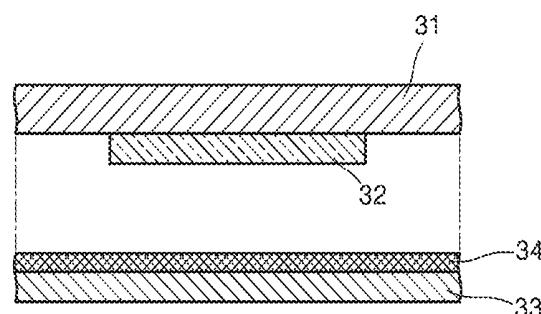


FIG. 3C

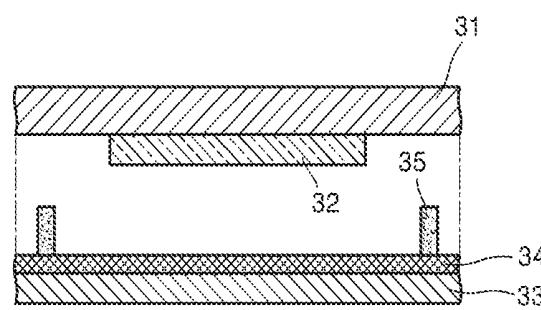


FIG. 3D

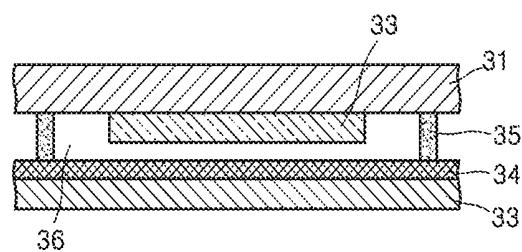


FIG. 4A

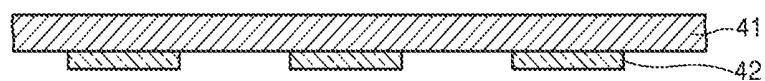


FIG. 4B

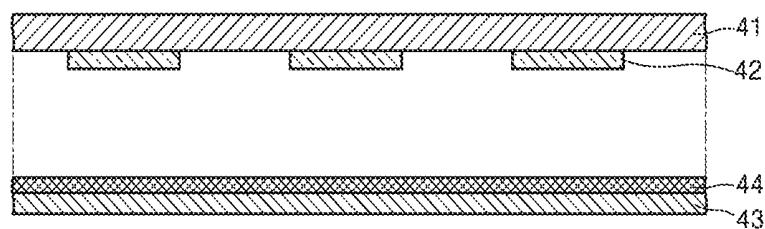


FIG. 4C

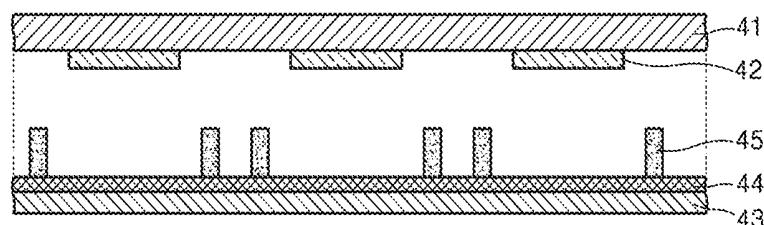


FIG. 4D

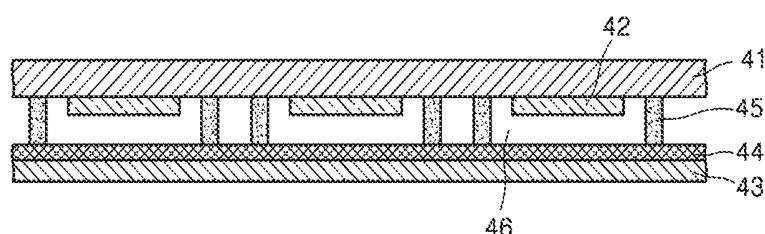


FIG. 4E

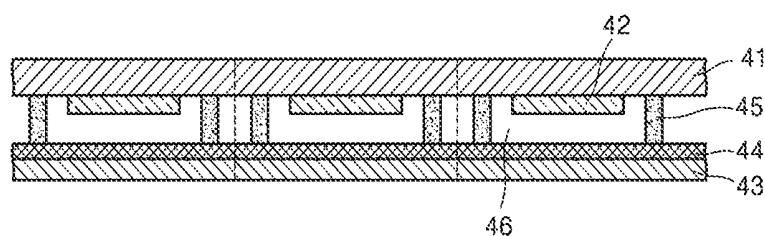


FIG. 5

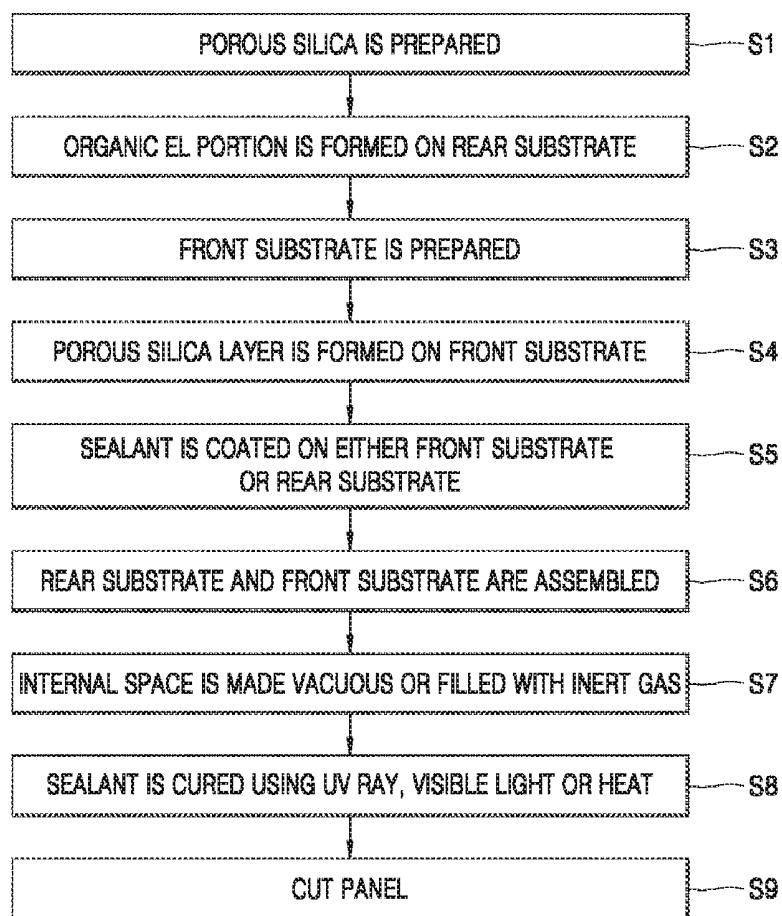
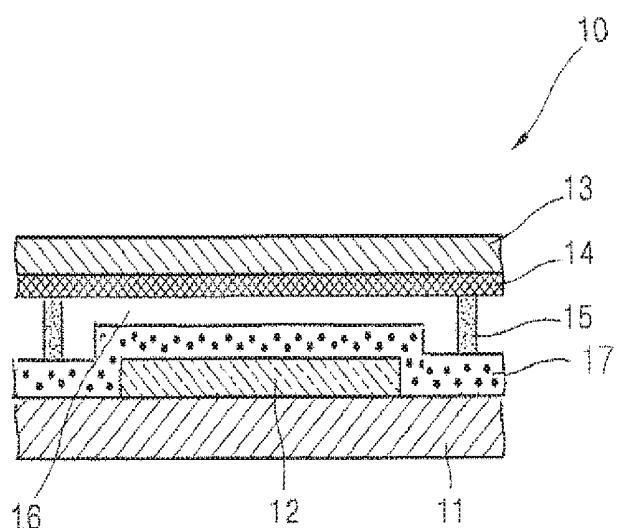


FIG. 6



ORGANIC ELECTROLUMINESCENT DISPLAY DEVICE AND METHOD OF MANUFACTURING THE SAME

CROSS REFERENCE TO RELATED APPLICATIONS

[0001] This application is a continuation of U.S. application Ser. No. 15/053,479, filed on Feb. 25, 2016, which is a continuation of Ser. No. 14/161,405, filed on Jan. 22, 2014, now U.S. Pat. No. 9,306,193, which is a divisional of U.S. application Ser. No. 11/934,577, filed on Nov. 2, 2007, now U.S. Pat. No. 8,652,566, which is a divisional of U.S. application Ser. No. 10/729,989, filed Dec. 9, 2003, now abandoned, and claims priority to and the benefit of Korean Patent Application No. 10-2003-0023219, filed on Apr. 12, 2003, which are all hereby incorporated by reference for all purposes as if fully set forth herein.

BACKGROUND OF THE INVENTION

Field of the Invention

[0002] The present invention relates to an organic electroluminescent (EL) display device and a method of manufacturing the same, and more particularly, to an organic EL display device with an improved encapsulation structure, and a method of manufacturing the same.

Background of the Invention

[0003] Generally, organic EL display devices are self-luminescent display devices which emit light by electrically exciting a fluorescent organic compound. They can be operated with low voltage and made thin. In addition, organic EL display devices have advantages, such as a wide viewing angle and a fast response speed, that overcome some of the problems of liquid crystal displays. Accordingly, it is expected that organic EL display devices may be applied to next generation displays that can overcome some of the shortcomings of liquid crystal displays.

[0004] In such organic EL display devices, an organic layer is formed in a predetermined pattern on a substrate made of glass or other transparent insulators. Electrode layers are disposed above and below the organic layers. The organic layers are made of organic compounds.

[0005] In organic EL display devices having the above-described structure, when positive and negative voltages are applied to the electrodes, holes are moved from an electrode, to which a positive voltage is applied, to an emission layer via a hole transport layer. Electrons are moved from an electrode, to which a negative voltage is applied, to the emission layer via an electron transport layer. The electrons meet the holes in the emission layer, thereby generating excitons. The excitons make a transition from an excitation state to a ground state, thereby causing fluorescent molecules of the emission layer to emit light. As a result, an image is formed.

[0006] In the aforementioned organic EL display devices, moisture absorbed into the device may result in deterioration of device performance. Thus, organic EL display devices may require an encapsulation structure for preventing infiltration of moisture.

[0007] In conventional organic EL display devices, several encapsulation techniques have been proposed, including methods in which a metal can or a glass substrate is

processed in the form of a cap having a groove to which a powdered absorbent for absorbing moisture is applied. Alternatively a film of the absorbent is adhered using a double-sided tape. However, since applying the absorbent to the groove may be quite complicated, the material and processing costs may increase, and the overall thickness of the substrate may increase. In the case of a powdered absorbent, it cannot be used for a front emission type display device since the substrate used for encapsulation is opaque. Meanwhile, in the case of a film-like absorbent, there is a limit to preventing the infiltration of moisture. Since the film-like absorbent may be easily damaged due to scratches or other external impacts during manufacture or use, high durability and reliability cannot be attained. Thus, the encapsulation structure using a film-like absorbent is not generally suitable for mass production of organic EL display devices.

[0008] Japanese Patent Laid-open Publication No. 9-148066 discloses an organic EL display device comprising a laminate in which organic luminescent material layers made of organic compounds are disposed between a pair of opposite electrodes and within a hermetic container for isolating the laminate from external air. A drying material is disposed in the hermetic container, wherein the drying material absorbs moisture so that the device maintains a solid state even as it absorbs moisture. Examples of the drying materials include alkali metal oxides, sulfuric salts and the like. Such an organic EL display device may become bulky due to the shape of a hermetic container. Also, even if the device is maintained at a solid state after absorption of the moisture, the device cannot be used for a front emission type display because of its opacity. Further, since the manufacturing process is complicated, the material cost and processing cost may increase.

[0009] Japanese Patent Laid-open Publication No. 5-335080 discloses a method of forming a protection film for an organic EL device. In the disclosed method, a shapeless silica protection film is formed on an organic EL device having an electroluminescent material layer containing at least one kind of organic compound between positive and negative electrodes, at least one of which is a transparent electrode. In the disclosed organic EL device, the structure for preventing moisture infiltration from the outside is configured such that dense, shapeless silica is thickly coated on one electrode. However, while the structure cannot absorb moisture inherently existing in the device, it can protect the organic EL device from external moisture. Thus, when using shapeless silica as a protective film material, separate structure for absorbing inherent moisture may be further necessary.

SUMMARY

[0010] An embodiment of the present invention provides an organic electroluminescent (EL) display device having absorbing structure by which a transparent state can be maintained so as to allow a front emission type display even after absorption of moisture. The present invention further provides a method of manufacturing the organic EL display device.

[0011] A further exemplary embodiment of the present invention provides an organic EL display device which can simplify the manufacturing process, thereby reducing material and processing costs.

[0012] An exemplary embodiment of the present invention discloses an organic electroluminescent display device

including a rear substrate, an organic electroluminescent portion disposed over a surface of the rear substrate, the organic electroluminescent portion including a first electrode, an organic layer, and a second electrode in sequence, a front substrate opposing the rear substrate and coupled to the rear substrate to seal an internal space therebetween in which the organic electroluminescent portion is accommodated, thereby isolating the organic electroluminescent portion from the outside, a moisture-absorbing layer disposed over an internal surface of the front substrate, and a sealant disposed between the rear substrate and the moisture-absorbing layer to couple the front substrate and the rear substrate.

[0013] The transparent moisture-absorbing layer may include absorption holes.

[0014] Each of the absorption holes may have a diameter in a range of about 0.5 nm to about 100 nm.

[0015] The transparent moisture-absorbing layer may have a thickness range of about 100 nm to about 50 μ m.

[0016] Each of the absorption holes may have a diameter in a range of about 0.5 nm to about 100 nm.

[0017] The first electrode of the organic electroluminescent portion may include a transparent electrode, and the second electrode of the organic electroluminescent portion may include a reflection-type electrode.

[0018] The first electrode of the organic electroluminescent portion may include a reflection-type electrode, and the second electrode of the organic electroluminescent portion may include a transparent electrode.

[0019] An inorganic protection layer may be disposed over the second electrode.

[0020] The inorganic protection layer may include one of a metal oxide and a metal nitride.

[0021] The internal space defined by the front substrate and the rear substrate may be configured to be vacuous.

[0022] The internal space defined by the front substrate and the rear substrate may be configured to be filled with an inert gas.

[0023] The front substrate may include one of a glass substrate and a plastic substrate.

[0024] A protection layer for protecting the front substrate from moisture may be disposed over one of the internal surface and an outer surface of the front substrate.

BRIEF DESCRIPTION OF THE DRAWINGS

[0025] The above and other features and advantages of the present invention will become more apparent by describing in detail exemplary embodiments thereof with reference to the attached drawings in which:

[0026] FIG. 1 is a cross-sectional view of an organic EL display device according to an embodiment of the present invention;

[0027] FIG. 2 is a cross-sectional view of a porous silica layer used in an organic EL display device according to an embodiment of the present invention;

[0028] FIGS. 3A through 3D are cross-sectional views of steps in a method of manufacturing a single organic EL display device according to an embodiment of the present invention;

[0029] FIGS. 4A through 4E are cross-sectional views of steps in a method of manufacturing a plurality of organic EL display devices according to an embodiment of the present invention; and

[0030] FIG. 5 is a flow diagram illustrating a method of manufacturing an organic EL display devices according to an embodiment of the present invention.

[0031] FIG. 6 is a cross-sectional view of an organic EL display device according to an exemplary embodiment of the present invention.

DETAILED DESCRIPTION OF THE ILLUSTRATED EMBODIMENTS

[0032] Reference will now be made in detail to exemplary embodiments of the present invention, examples of which are illustrated in the accompanying drawings.

[0033] FIG. 1 is a cross-sectional view of an organic EL display device according to an embodiment of the present invention. Referring to FIG. 1, an organic EL display device 10 includes a rear substrate 11 made of glass or a transparent insulator, an organic EL portion 12 formed on one surface of the rear substrate 11 and having a first electrode, an organic layer and a second electrode sequentially laminated. A front substrate 13 is coupled to the rear substrate 11 to seal an internal space 16 in which the organic EL portion 12 is accommodated, for isolating the organic EL portion 12 from the outside. The front substrate 13 has a transparent moisture-absorbing layer 14 coated on its internal surface.

[0034] The organic EL portion 12 may be formed by sequentially depositing a first electrode, an organic layer and a second electrode, so that the first electrode serves as a positive electrode and the second electrode serves as a negative electrode. The organic layer may include at least an emission layer. Also, the organic EL portion 12 may include a first electrode as a positive electrode, a hole transport layer, an emission layer, an electron transport layer, and a second electrode as a negative electrode.

[0035] The front substrate 13 may be a glass substrate that is an insulator, a transparent plastic substrate or similar material. In the case of the transparent plastic substrate, a protection layer for protecting the plastic substrate against moisture may be formed on the internal or the outer surface of the plastic substrate. The protection layer may have heat resistance, chemical resistance and/or moisture permeation resistance.

[0036] For a rear emission type display, the first electrode of the organic EL portion 12 may be a transparent electrode, and the second electrode of the organic EL portion 12 may be a reflection-type electrode. For a front emission type display, the first electrode of the organic EL portion 12 may be a reflection-type electrode, and the second electrode of the organic EL portion 12 may be a transparent electrode. The first electrode is disposed near the rear substrate 11, and the second electrode is disposed near the front substrate 13.

[0037] In order to impart heat resistance, chemical resistance, and/or moisture permeation resistance, an inorganic protection layer 17 for planarizing the top surface of the organic EL portion 12 may be further provided on the second electrode. The protection layer 17 may be made of metal oxide, metal nitride or similar material.

[0038] The internal space 16, defined by the front substrate 13 and the rear substrate 11, may be made vacuous, or may be filled with an inert gas, e.g., neon, argon, or other gas capable of performing the same function as the inert gas. The front substrate 13 and the rear substrate 11 are generally coupled to each other using a sealant 15.

[0039] The moisture-absorbing layer 14 may be a porous silica layer. The porous silica layer may have a thickness in

the range of about 100 nm to about 50 μm in view of manufacturing process and performance.

[0040] FIG. 2 shows a porous silica layer used as a moisture-absorbing layer in the organic EL device according to an exemplary embodiment of the present invention. Referring to FIG. 2, the porous silica layer 14 includes a silica frame 14a and absorption holes 14b. The silica frame 14a props up the construction of the porous silica layer 14, and the absorption holes 14b absorb moisture. As described above, the porous silica layer 14 is maintained at a transparent state before and after absorption of moisture.

[0041] According to an exemplary embodiment of the invention, the porous silica layer 14 may be fabricated as follows. A first mixture of 0.3 g surfactant and 0.6 g solvent is prepared. Polymers may be used as the surfactant, and a mixed solvent of propanol and butanol in a ratio of 1:2, may be used as the solvent. A second mixture of 5 g TEOS (Tetra-Ethyl-Ortho-Silicate), 10.65 g solvent and 1.85 g HCl is then prepared.

[0042] The second mixture is stirred for approximately 1 hour. 2.1 g of the second mixture is mixed with the first mixture, forming a third mixture. The third mixture is coated on a substrate, such as a glass substrate, used as the front substrate. Usable coating methods include spin coating, spray coating, roll coating and the like. The spin coating may be performed at 2000 rpm for 30 seconds. Next, the resulting structure is aged at room temperature for approximately 24 hours or at 40-50° C. for approximately 5 hours. In order to form absorption holes, firing is performed on the resulting structure at an oven maintained at approximately 400° C. for approximately 2 hours so that the polymer is burnt. The formed porous silica layer has a thickness of approximately 7000 \AA . The above-described process is repeated, thereby forming a thin film having a thickness of approximately 3.5 μm . Values indicating the amount of materials as described above are only used to indicate the ratios thereof in the mixture, and it is recognized that specific values may be adjusted accordingly.

[0043] The thus-formed porous silica layer 14 includes large absorption holes 14b in its structure, as shown in FIG. 2. While each of the absorption holes 14b is generally 2-30 nm in diameter, the diameter may be adjusted by adjusting the size of the polymer used in the first mixture. The density of the absorption holes 14b formed in the porous silica layer 14 may be approximately 80% of the area (e.g. 80% of the area of the porous silica layer 14 is occupied by absorption holes 14b). As described above, the porous silica layer 14 may be formed by spin coating, spray coating, or roll coating, and may have high mechanical and thermal stability. Also, the formation process of the porous silica layer 14 may be relatively easily controlled.

[0044] FIGS. 3A through 3D illustrate steps in a method of manufacturing a single organic EL display device according to an exemplary embodiment of the present invention. As shown in FIG. 3A, a rear substrate 31 having an organic EL portion 32 is prepared. Then as described above, a porous silica layer 34 is coated on the inner surface of a front substrate 33, as shown in FIG. 3B. The front substrate 33 coated with the porous silica layer 34 is cleaned to remove foreign matter and organic material on its surface, and is left in a vacuous oven maintained at 150° C. for approximately 1 hour for desorption of moisture absorbed into the porous silica layer 34. Thereafter, a sealant 35 is coated outside the organic EL portion disposed on at least one of the rear

substrate 31 and the front substrate 33, as shown in FIG. 3C, using a screen printer or a dispenser. As shown in FIG. 3D, the front substrate 33 and the rear substrate 31 are assembled in an assembly chamber.

[0045] In addition, an internal space 36 defined by the front and rear substrates of the thus-formed organic EL device may be made. Internal space 36 may be vacuous or filled with an inert gas. The sealant 35 may be cured using UV rays, visible light and/or heat after assembling the front substrate 33 and the rear substrate 31.

[0046] FIGS. 4A through 4E are cross-sectional views of steps in a method of manufacturing a plurality of organic EL display devices according to an exemplary embodiment of the invention. First, a rear substrate 41 having a plurality of organic EL portions 42 is prepared. A porous silica layer 44 is coated on the inner surface of a front substrate 43 by the above-described method, as shown in FIG. 4B. A sealant 45 is coated outside each of the plurality of organic EL portions disposed on at least one of the rear substrate 41 and the front substrate 43, as shown in FIG. 4C. The rear substrate 41 and the front substrate 43 are assembled to each other, as shown in FIG. 4D, forming a panel having a plurality of organic EL devices mounted thereon. The panel may then be cut, as shown in FIG. 4E, to provide individual organic EL devices. As with the manufacture of a single organic EL device, an internal space 46 defined by the front and rear substrates 43 and 41 may be made. The internal space 46 may be vacuous or filled with an inert gas. The sealant 45 may be cured using UV rays, visible light and/or heat.

[0047] FIG. 5 is a flow diagram illustrating a method of manufacturing an organic EL display device according to an exemplary embodiment of the present invention.

[0048] Porous silica is prepared by the above-described method (step S1). An organic EL portion is formed on a rear substrate (step S2). A front substrate is prepared (step S3), and a porous silica layer is formed on the prepared front substrate (step S4). A sealant is coated on either the front substrate or the rear substrate (step S5). The rear substrate and the front substrate are assembled (step S6). An internal space defined by the front substrate and the rear substrate is made vacuous or filled with an inert gas (step S7). The sealant is cured using UV rays, visible light and/or heat (step S8). A panel having a plurality of organic EL devices is cut (step S9).

[0049] According to the present invention, a 3 cm by 4 cm sized, organic EL device having absorbing material of about 3.5 μm thickness may be produced. The absorbing material can absorb several to several tens of milligrams of moisture depending on the density of the absorbing material. The absorption level is not inferior to that of a typical desiccant, such as CaO or BaO, and the encapsulation effect can be ensured for approximately 30,000 to approximately 50,000 hours while maintaining the transparency of the substrate of the organic EL device having the absorbing material.

[0050] As described above, the organic EL device may have a transparent moisture-absorbing layer made of porous silica. According to an embodiment of the present invention, since the substrate used for encapsulation is transparent, it can be used for a front emission type display.

[0051] Also, as it is not necessary to form a separate groove in the front substrate to be used as an encapsulation substrate, the manufacturing process may be simplified, thereby reducing the processing cost and the material cost.

[0052] FIG. 6 is a cross-sectional view of an organic EL display device according to an exemplary embodiment of the present invention. Referring to FIG. 6, an inorganic protection layer 17 is disposed on the second electrode of the organic EL portion 12.

[0053] Further, since the front substrate is relatively thin, the overall volume of the organic EL display device is reduced, thereby achieving miniaturization of the organic EL device.

[0054] Although a few embodiments of the present invention have been shown and described, it will be appreciated by those of ordinary skill in the art that changes may be made in these elements without departing from the principles and spirit of the invention, the scope of which is defined in the appended claims and their equivalents.

What is claimed is:

1. An organic electroluminescent display device, comprising:
 - a rear substrate;
 - an organic electroluminescent portion disposed over a surface of the rear substrate, the organic electroluminescent portion comprising a first electrode, an organic layer, and a second electrode in sequence;
 - a front substrate opposing the rear substrate and coupled to the rear substrate to seal an internal space therebetween in which the organic electroluminescent portion is accommodated, thereby isolating the organic electroluminescent portion from the outside;
 - a moisture-absorbing layer disposed over an internal surface of the front substrate; and
 - a sealant disposed between the rear substrate and the moisture-absorbing layer to couple the front substrate and the rear substrate.
2. The organic electroluminescent display device of claim 1, wherein the transparent moisture-absorbing layer comprises absorption holes.
3. The organic electroluminescent display device of claim 2, wherein each of the absorption holes has a diameter in a range of about 0.5 nm to about 100 nm.

4. The organic electroluminescent display device of claim 2, wherein the transparent moisture-absorbing layer has a thickness range of about 100 nm to about 50 μ m.

5. The organic electroluminescent display device of claim 4, wherein each of the absorption holes has a diameter in a range of about 0.5 nm to about 100 nm.

6. The organic electroluminescent display device of claim 1, wherein:

the first electrode of the organic electroluminescent portion comprises a transparent electrode; and
the second electrode of the organic electroluminescent portion comprises a reflection-type electrode.

7. The organic electroluminescent display device of claim 1, wherein:

the first electrode of the organic electroluminescent portion comprises a reflection-type electrode; and
the second electrode of the organic electroluminescent portion comprises a transparent electrode.

8. The organic electroluminescent display device of claim 1, wherein an inorganic protection layer is disposed over the second electrode.

9. The organic electroluminescent display device of claim 8, wherein the inorganic protection layer comprises one of a metal oxide and a metal nitride.

10. The organic electroluminescent display device of claim 1, wherein the internal space defined by the front substrate and the rear substrate is configured to be vacuous.

11. The organic electroluminescent display device of claim 1, wherein the internal space defined by the front substrate and the rear substrate is configured to be filled with an inert gas.

12. The organic electroluminescent display device of claim 1, wherein the front substrate comprises one of a glass substrate and a plastic substrate.

13. The organic electroluminescent display device of claim 12, wherein a protection layer for protecting the front substrate from moisture is disposed over one of the internal surface and an outer surface of the front substrate.

* * * * *

专利名称(译)	有机电致发光显示装置及其制造方法		
公开(公告)号	US20170309865A1	公开(公告)日	2017-10-26
申请号	US15/640578	申请日	2017-07-02
[标]申请(专利权)人(译)	三星显示有限公司		
申请(专利权)人(译)	三星DISPLAY CO. , LTD.		
当前申请(专利权)人(译)	三星DISPLAY CO. , LTD.		
[标]发明人	PARK JIN WOO LEE JONG HYUK		
发明人	PARK, JIN-WOO LEE, JONG-HYUK		
IPC分类号	H01L51/52 H01L51/56 H05B33/04 H01L51/50 H05B33/10 H05B33/14		
CPC分类号	H01L2251/558 H01L51/56 H01L2251/5315 H01L51/524 H01L51/5253 H01L51/5259 H01L51/5206 H01L51/5221 H01L51/5246 H01L2251/301 H01L2251/303 H01L51/5237		
优先权	1020030023219 2003-04-12 KR		
其他公开文献	US10135030		
外部链接	Espacenet USPTO		

摘要(译)

一种有机电致发光显示装置，包括后基板，设置在后基板表面上的有机电致发光部分，有机电致发光部分依次包括第一电极，有机层和第二电极，与后基板相对的前基板并且连接到后基板以密封其间容纳有机电致发光部分的内部空间，从而将有机电致发光部分与外部隔离，设置在前基板的内表面上的吸湿层和设置的密封剂在后基板和吸湿层之间连接前基板和后基板。

